TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

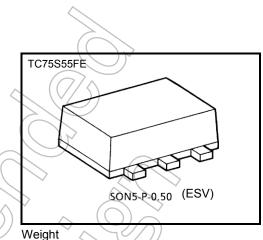
# TC75S55FE

#### Single Operational Amplifier

The TC75S55FE is a CMOS single-operation amplifier which incorporates a phase compensation circuit. It is designed for use with a low-voltage, lowcurrent power supply; this differentiates this device from conventional general-purpose bipolar op-amps.

#### Features

- Low-voltage operation  $V_{DD} = \pm 0.9$  to 3.5 V or 1.8 to 7 V
- Low-current power supply :  $I_{DD}$  ( $V_{DD}$  = 3 V) = 10  $\mu$ A (typ.)
- Built-in phase-compensated op-amp, obviating the need for any external device
- Ultra-compact package





### Absolute Maximum Ratings (Ta = 25°C

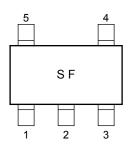
Characteristics	Symbol	Rating	Unit	~
Supply voltage	V <sub>DD</sub> , V <sub>SS</sub>	$\left( \begin{array}{c} \uparrow \uparrow \end{array} \right)$	V	$\left  \right $
Differential input voltage	DVIN	<u>±</u> 7	V	7
Input voltage	Vin	V <sub>DD to</sub> V <sub>SS</sub>	V	7,
Power dissipation	PD	100	mW	
Operating temperature	Topr	-40 to 85	)°C	)
Storage temperature	T <sub>stg</sub>	-55 to 125	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production 1995-01

### Marking (top view)



#### **Electrical Characteristics**

### DC Characteristics ( $V_{DD} = 3.0 V$ , $V_{SS} = GND$ , $Ta = 25^{\circ}C$

Characteristics (V <sub>DD</sub> = 3	$0 V, V_{SS} = 0$	GND,	Ta = 25°C)		~((		
Characteristics	Symbol	Test Circuit	Test Condition	Min	Exp.	Max	Unit
Input offset voltage	Vio	1	Rs = 10 kΩ	$\diamond - \langle$	2/	10	mV
Input offset current	liO			1	L FC	]	pА
Input bias current	lı		$\sim$	6	Y		pА
Common mode input voltage	CMVIN	2		0.0	/_	2.1	V
Voltage gain (open loop)	Gv	- (	$\sim \sim - (7)$	60	70	_	dB
	Vон	3	RL≥1 MΩ	2.9	_	_	V
Maximum output voltage	Vol	4	R <sub>L</sub> ≥1 MΩ	_	_	0.1	V
Common mode input signal Rejection Ratio	CMRR	2	VIN = 0.0 to 2.1 V	60	70		dB
Supply voltage rejection ratio	SVRR		V <sub>DD</sub> = 1.8 to 7.0 V	60	70	_	dB
Supply current	ldd	) 5	A	_	10	20	μA
Source current	Isource	6		10	20	_	μA
Sink current	Isink	7		100	450		μA

### DC Characteristics ( $V_{DD} = 1.8 V$ , $V_{SS} = GND$ , $Ta = 25^{\circ}C$ )

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	VIO	1	R <sub>S</sub> = 100 kΩ	_	2	10	mV
Input offset current	liø (	_	—	_	1	_	pА
Input bias current	+		—	_	1	_	pА
Common mode input voltage	CMVIN	2	—	0.0	_	0.9	V
Voltage gain (open loop)	GV	_	—	60	70	_	dB
Maximum output voltage	Voн	3	R <sub>L</sub> ≥ 1 MΩ	1.7	_	_	V
	Vol	4	R <sub>L</sub> ≥ 1 MΩ	_	_	0.1	V
Supply current	IDD	5	—	_	8	16	μA
Source current	Isource	6	_	8	16	_	μA
Sink current	I <sub>sink</sub>	7	_	100	400	_	μA

Pin Connection (top view)

Vdd

5

1

IN (+)

2

Vss

OUT

4

3

/N (-)

#### AC Characteristics ( $V_{DD} = 3.0 V$ , $V_{SS} = GND$ , $Ta = 25^{\circ}C$ )

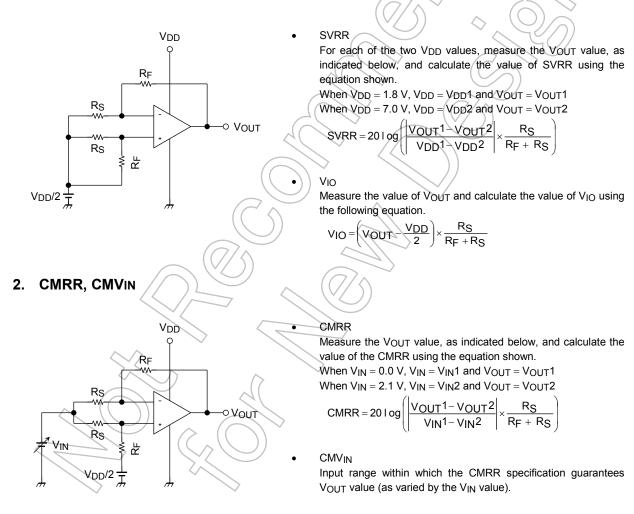
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Slew rate	SR		_	_	0.08	_	V/μs
Unity gain cross frequency	f⊤			_	160		kHz
				$\sim$			

#### AC Characteristics ( $V_{DD} = 1.8 V$ , $V_{SS} = GND$ , $Ta = 25^{\circ}C$ )

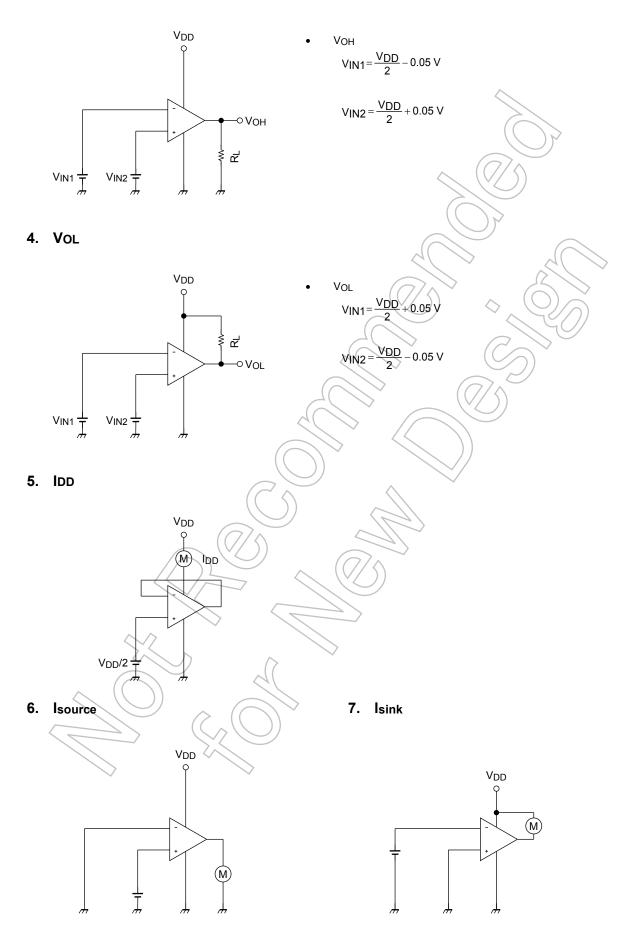
Characteristics	Symbol	Test Circuit	Test Condition Min Typ. Max Ur	nit
Slew rate	SR	_	— 0.06 — V/µ	μS
Unity gain cross frequency	f⊤	—	140 k⊢	Ιz

#### **Test Circuit**

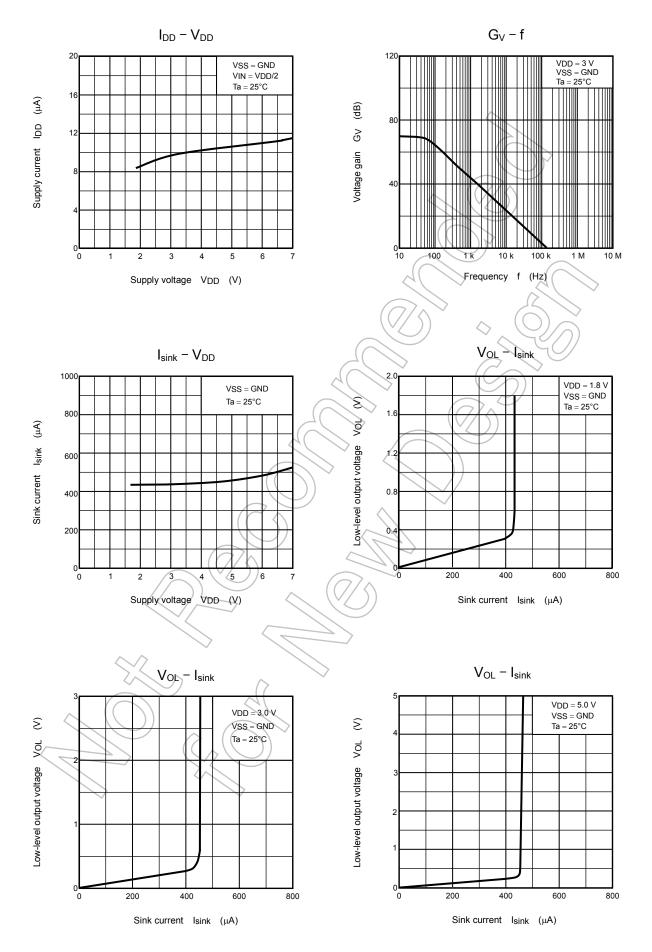
1. SVRR, VIO



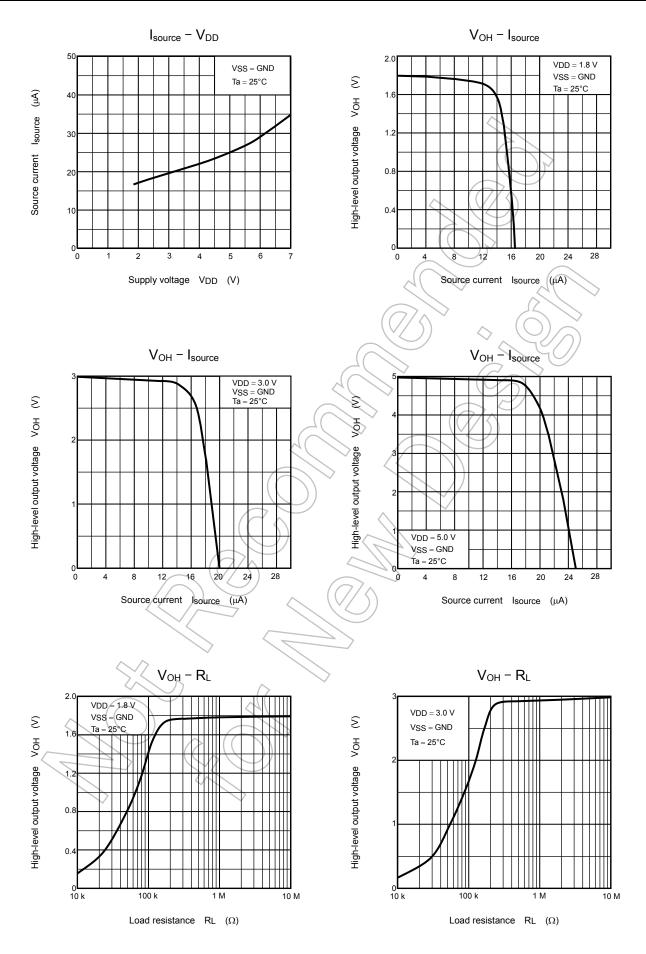
3. Vон



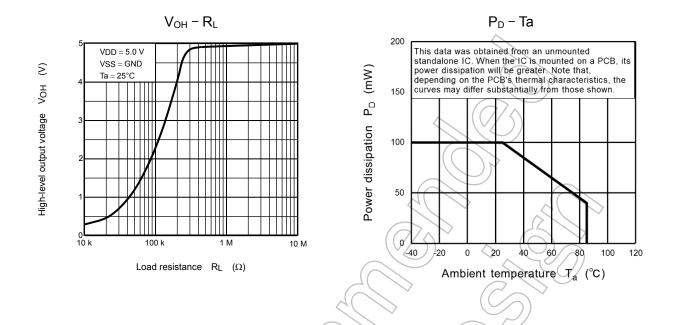
### TC75S55FE



The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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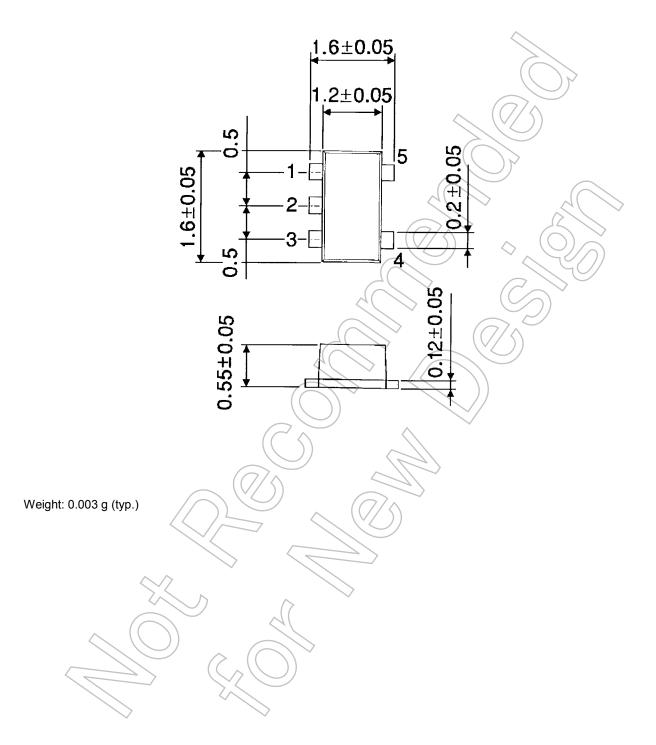
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#### **Package Dimensions**

SON5-P-0.50

Unit : mm



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